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DIALOG(R)File 351:Derwent WPI
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WPI Acc No: 1988-039752/*198806*

XRAM Acc No: C88-017806

**Cosmetic material for skin conditioning - contains organic silicone resin
and volatile silicone oil**

Patent Assignee: SHINETSU CHEM IND CO LTD (SHIE); SHISEIDO CO LTD (SHIS
)

Number of Countries: 001 Number of Patents: 001

Patent Family:

Patent No	Kind	Date	Applicat No	Kind	Date	Week
JP 62298519	A	19871225	JP 86143760	A	19860619	198806 B

Priority Applications (No Type Date): JP 86143760 A 19860619

Patent Details:

Patent No	Kind	Lan Pg	Main IPC	Filing Notes
JP 62298519	A	4		

Abstract (Basic): JP 62298519 A

Material contains (A) 1-90 wt.% of organic silicone resin, 70 mol.% or more of which comprises $R_3SiO_{1/2}$ unit and SiO_2 unit of mol. ratio 0.5/1-1.5/1 contg. R_2SiO and/or $RSiO_{3/2}$ units 1-30 mol.% (R is hydrocarbon gp. or phenyl gp. of carbon number 1-6), and (B) 10-99 wt.% of volatile silicone oil of formula (I) or (II) where n is 0-5 in (I) and 3-7 in (II).

USE - The material effectively protects skin (esp. hands) from roughness caused by the work using water for long time. It is smoothly applied and not washed away easily by washing with water.

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Title Terms: COSMETIC; MATERIAL; SKIN; CONDITION; CONTAIN; ORGANIC;
SILICONE; RESIN; VOLATILE; SILICONE; OIL

Derwent Class: A26; A96; D21

International Patent Class (Additional): A61K-007/48

File Segment: CPI